

# Maintenance Manager

## 1 Position

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### Specification



Male



Age 35 years old Upward.



Bachelor's degree in **Mechanical Engineering** / **Electronic Engineering**.



1. Have experience at least 5 years about Maintenance Management for Semiconductor manufacturing.
2. Have knowledge about ICS packaging at Dicing, Die Bond and Wire Bonding Process .
3. Experienced in machine maintenance for Dicing, Die Bonding and Wire Bonding Machine.
4. Experienced in defects analysis and quality improvement.
5. Knowledge in IATF 16949 and Environmental Management System.

### Responsibility

1. Management of maintenance job and assign work order for all maintainer to be produced according to production plans.
2. Developing company policies for all maintenance work.
3. Improve Productivity and Quality up.
4. Planning and Carry out the maintainer skill up.
5. Management of Budgets.

**Only all evidences submitted applicant will be considered**



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